



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



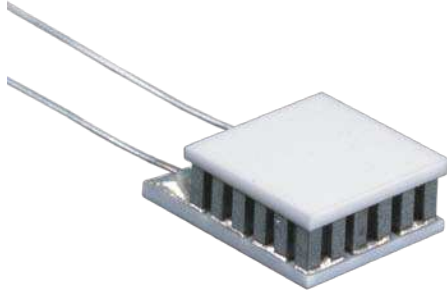
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The OptoTEC™ Series is a miniature thermoelectric module (TEM). This product series is primarily used in applications to stabilize the temperature of sensitive optical components in telecom and photonics industries.

This product line is available in multiple configurations and surface finishing options. Assembled with Bismuth Telluride semiconductor material and thermally conductive Aluminum Oxide ceramics, the OptoTEC Series is designed for lower current and lower heat-pumping applications. Custom designs are available to accommodate metallization, pretinning, ceramic patterns, and solder posts, however MOQ applies.

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### FEATURES

- Miniature geometric sizes
- Precise temperature control
- Reliable solid state operation
- No sound or vibration
- DC operation
- RoHS compliant

### APPLICATIONS

- Laser diodes
- CCD cameras
- Calibration equipment
- Infrared (IR) sensors
- Pump lasers
- Crystal oscillators
- Optical transceivers

### SPECIFICATIONS

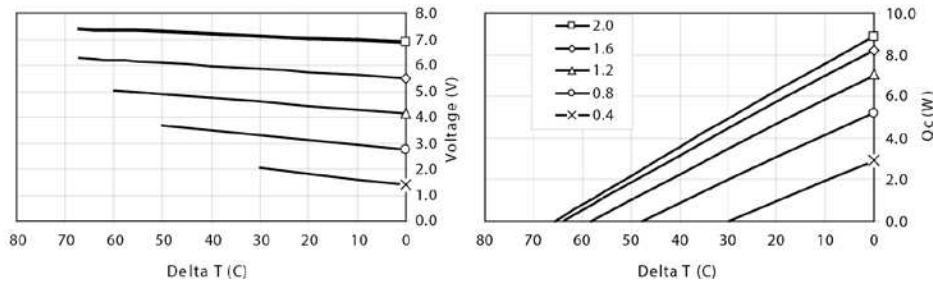
PERFORMANCE		
Hot Side Temperature (°C)	25°C	50
Qmax (Watts)	8.9	9.8
Delta Tmax (°C)	67	77
Imax (Amps)	2.0	2.0
Vmax (Volts)	7.4	8.4
Module resistance (ohms)	3.39	3.82

SUFFIX	THICKNESS PRIOR TO TINNING	FLATNESS & PARALLELISM	HOT FACE	COLD FACE	LEAD LENGTH
11	0.086" ± 0.002"	0.0002" / 0.002"	Lapped	Lapped	2.0"
TB	0.086" ± 0.0005"	0.0005" / 0.0005"	Lapped	Lapped	2.0"
00	0.098" ± 0.005"	NA / NA	Metallized	Metallized	2.0"
22	0.098" ± 0.005"	NA / NA	Pre-tinned	Pre-tinned	2.0"
GG	0.098" ± 0.005"	NA / NA	AuPlated	AuPlated	2.0"

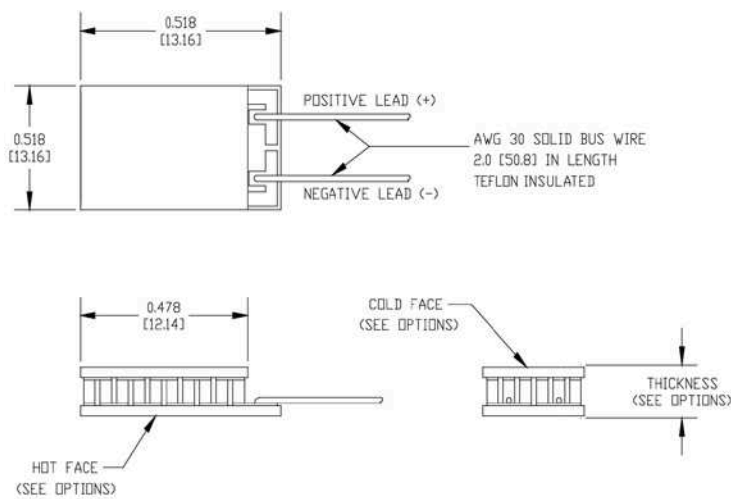
### SEALING OPTIONS

SUFFIX	SEALANT	COLOR	TEMP RANGE	DESCRIPTION
RT	RTV	White	-60 to 204 °C	Non-corrosive, silicone adhesive sealant
EP	Epoxy	Black	-55 to 150 °C	Low density syntactic foam epoxy encapsulant

### PERFORMANCE CURVES



### MECHANICAL DRAWING



Ceramic Material: 96% Alumina Ceramics

Solder Construction: 271°C, Proprietary

### OPERATING TIPS

- Max operating temperature: 175°C
- Do not exceed I<sub>max</sub> or V<sub>max</sub> when operating module
- Reference assembly guidelines for recommended installation
- Solder tinning also available on metallized ceramics

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